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(54) **SOLID STATE DRIVE TO AVOID
ELECTROMAGNETIC INTERFERENCE BY
CHANGING THE LENGTH OF BOTTOM
PLANE**

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(57) **ABSTRACT**

The embodiments of the present disclosure relate to a solid state drive. According to embodiments of the present disclosure, the solid state drive may include a notch fastening part in which a notch connecting the solid state drive and a platform outside the solid state drive is fastened, a coupling part coupled to the socket of the platform, and a bottom plane that is a printed circuit board (PCB) plane that forms a cavity between the top plane of the platform when the coupling part is coupled to the socket of the platform.

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